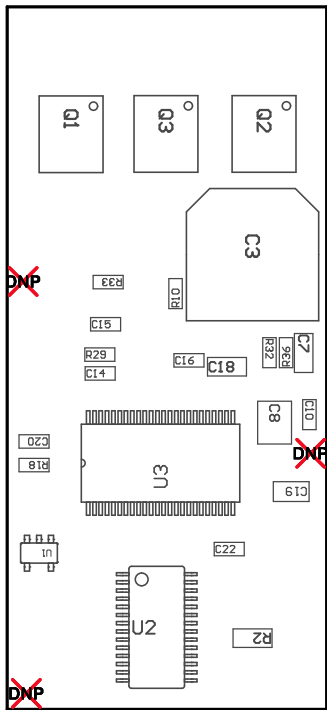
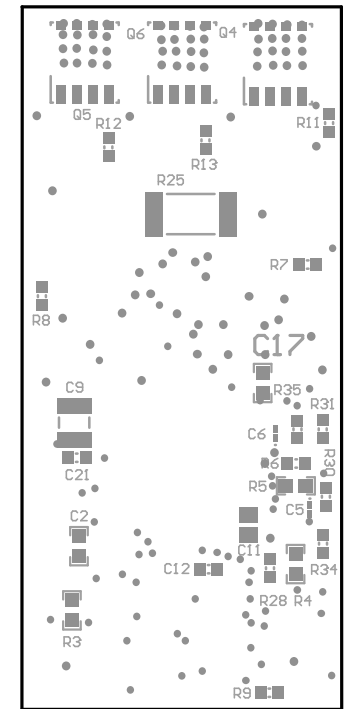


- Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00735	REV: Rev A	SUN REV: Not In VersionControl
	TID #: 00735		
PLOT NAME = Top Assembly Drawing	GENERATED : 11/19/2015	3:32:09 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00735	REV: Rev A	SUN REV: Not In VersionControl
	TID #: 00735 Bottom Assembly Drawing		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 11/19/2015 3:32:10 PM		TEXAS INSTRUMENTS

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